

Claim Amendments

Claim 1. (currently amended):

A projection lithography system, for curved surface lithography, having a number of required transmissive elements in a light path controlled by projection optics and illumination optics, in which ~~characterized in that:~~

the illumination optics has means to form an illumination compensator having the zero-power aggregate optical effect of two closely-spaced identical meniscus elements back-to-back, and the system is designed to provide patterning illumination to a curved substrate (3) in accordance with a curved mask (2), whose size and curvature are related to the size and curvature of the curved substrate (3);

characterized by:

a) radiation means (7):

b) projection means (5):

c) scanning means (8), to present, for scanning, both such curved mask (2) and such curved substrate (3) for imaging mask to substrate via said projection means (5), with means to move said projection means (5);

whereby a scanning polygon of the curved mask pattern is imaged onto the curved substrate surface, and the substrate surface remains within the depth-of-focus of said projection means and said scanning polygon remains at substantially the same size: and

d) means (1) in the illumination light path supporting such mask means (2) is arranged to transmit the scanning beam undistorted in its shape and direction of propagation.

Claim 2. (currently amended)

~~A projection lithography system for imaging a microelectronics pattern according to Claim 1~~

~~_____ further characterized by:~~

A projection lithography system, for curved surface lithography, having a number of required transmissive elements in a light path controlled by projection optics and illumination optics

_____ characterized in that:

the illumination optics has means to form an illumination compensator having the zero-power aggregate optical effect of two closely-spaced identical meniscus elements back-to-back, characterized by:

- a) a curved substrate (3);
- b) a curved mask (2), whose size and curvature are related to the size and curvature of the curved substrate (3);
- c) radiation means (7);
- d) projection means (5); and
- e) scanning means (8), to present, for scanning, both said curved mask (2) and said curved substrate (3) for imaging mask to substrate via said projection means (5), with means to move said projection means (5); whereby the curved mask pattern is imaged onto the curved substrate surface, and the substrate surface remains within the depth-of-focus of said projection means and said scanning polygon remains at substantially the same size: and

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f) means (1) in the illumination light path supporting said mask means (2) to transmit the scanning beam undistorted in its shape and direction of propagation.

Claim 3. (previously presented)

A projection lithography system for curved surface lithography, having a number of required transmissive elements in a light path controlled by projection optics and illumination optics

characterized in that:

the illumination optics has means to form an illumination compensator having the zero-power aggregate optical effect of two closely-spaced identical meniscus elements back-to-back;

further characterized by:

- a) a curved substrate (3);**
- b) a curved mask (2), whose size and curvature are related to the size and curvature of the curved substrate (3);**
- c) radiation means (7);**
- d) projection means (5); and**
- e) scanning means (8), to present, for scanning, both said curved mask (2) and said curved substrate (3) for imaging mask to substrate via said projection means (5), with means to move said projection means (5); whereby the curved mask pattern is imaged onto the curved substrate surface, and the substrate surface remains within the depth-of-focus of said projection means and said scanning polygon remains at substantially the same size: and**
- f) zero-power meniscus lens pair means (1) in the illumination light path supporting said mask means (2) to transmit the scanning beam undistorted in its shape and direction of propagation;**

wherein said curved mask (2) is a photo-opaque pattern on the curved exit surface of said zero-power meniscus lens pair means (1).

Claim 4. (previously presented)

A projection lithography system, for curved surface lithography, having a number of required transmissive elements in a light path controlled by projection optics and illumination optics

characterized in that:

the illumination optics has means to form an illumination compensator having the zero-power aggregate optical effect of two closely-spaced identical meniscus elements back-to-back, wherein said curved mask (12) is identical in size and shape but opposite in convexity orientation to said curved substrate (11),

further characterized by:

means to control defocus while scanning said curved mask (1) on said scanning means (15) by providing motion to said projection means or, as an alternative, to provide opposite motions to said mask and said substrate, along the optic axis of said lens, to correct for magnification errors by maintaining distances from object and conjugate image points to principal planes of said lens; and

zoom control means to provide controlled motion to said condensing means calculated to keep the size of the illumination beam constant on said mask (1).

5. (original) :

A projection lithography system according to Claim 4,

further characterized by

means to provide compensating motion to said projection means (5), to maintain total track length to within the depth-of-focus; and

zoom capability in said condensing means, calculated to keep the illumination beam focused on said curved mask with constant size.

Claim 6. (previously presented)

A projection lithography system, for curved surface lithography, having a number of required transmissive elements in a light path controlled by projection optics and illumination optics

characterized in that:

the illumination optics has means to form an illumination compensator having the zero-power aggregate optical effect of two closely-spaced identical meniscus elements back-to-back: ____

further characterized by:

- a) a curved substrate (3);
- b) a curved mask (2), whose size and curvature are related to the size and curvature of the curved substrate (3);
- c) radiation means (7);
- d) projection means (5); and
- e) scanning means (8), to present, for scanning, both said curved mask (2) and said curved substrate (3) for imaging mask to substrate via said projection means (5), with means to move said projection means (5); whereby the curved mask pattern is imaged onto the curved substrate surface, and the substrate surface remains within the depth-of-focus of said projection means and said scanning polygon remains at substantially the same size: and
- f) zero-power meniscus lens pair means (1) in the illumination light path supporting said mask means (2) to transmit the scanning beam undistorted in its shape and direction of propagation;

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wherein said curved mask (2) is identical in size and shape but complementary in convexity orientation to said curved substrate (3);

further characterized in that

said zero-power meniscus lens pair means (1) has two oppositely-oriented optical elements aggregating zero power, having an entry face and an exit face; and

a curved patterning mask positioned directly on the exit face of said zero-power meniscus lens pair means (1).

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Claim 7 (previously presented) :

A projection lithography system according to Claim 6,
further characterized in that

said zero-power meniscus lens pair means (1). has a patterning mask element positioned in the projection beam path so that said zero-power meniscus lens pair means (1) elements when aggregated form a zero-power refractive device to direct the mask pattern forward.

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Claim 8. (previously presented) :

A projection lithography system according to Claim 7,
further characterized in that
said zero-power meniscus lens pair means (1). has a concave entry
surface and a concave exit surface.

Claim 9 (previously presented):

A projection lithography system according to Claim 7,
further characterized in that
said zero-power meniscus lens pair means (1). has a convex entry
surface and a convex exit surface.

~~Claim 10. (currently amended) :~~

~~A projection lithography system having a zero-power meniscus lens pair
means (1) as mask support for a flexible film curved mask.~~

~~Claim 11. (currently amended) :~~

~~A projection lithography system having a zero-power meniscus lens pair
means (1) with the exit surface as mask support for a flexible film curved mask.~~

¹⁰
Claim ~~12~~. (previously presented)

A projection lithography system according to Claim 7,

characterized by:

a) an optically transparent mask body having surface curvature identical to known curvature of the substrate, having a photo-opaque pattern layer on said surface; and

b) means forming a zero-power meniscus

lens pair means (1) with said mask body by mounting an oppositely oriented optically transparent compensating body in close proximity in the light path.

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~~Claim 13.~~ (previously presented) :

A projection lithography system for imaging a pattern from a curved mask onto a curved substrate, thereby maintaining the image within the depth of focus of the projection optics, using scanning techniques,

characterized by:

- a) a curved substrate (3) mounted on a scanning platform;
 - b) a curved transmissive mask (2), having an inverted orientation with respect to said curved substrate (3), mounted on said scanning platform;
 - c) radiation means (7);
 - d) projection means (5);
 - e) scanning means (8), to present, for scanning and imaging a pattern from said curved mask (2) to curved substrate (3) via said projection means (5);
- and
- f) zero-power meniscus

lens pair means (1) to minimize the effects of image anomalies related to curved mask (2) and support.

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Claim 14 (withdrawn)

A curved mask (2) for a projection lithography system, for use in imaging a pattern from its surface to the surface of a curved substrate of known curvature

characterized by:

a) an optically transparent mask body having surface curvature identical to said known curvature of the substrate, having a photo-opaque pattern layer at said surface; and

b) means forming a Zerogon (1) with said mask body by mounting an oppositely oriented optically transparent compensating body in close proximity in the light path.

Claim 15. (withdrawn) :

A curved mask (2) according to Claim 14, wherein said optically transparent mask body and said optically transparent compensating body are of fused silica.

Claim 16 (withdrawn) :

16. A projection lithography mask according to Claim 15 having a photo-opaque pattern layer is selected from aluminum and chrome on said curved mask (12).

Claim 17. (withdrawn) :

A projection lithography mask made by the following contact lithography / non-contact lithography process, starting with a planar mask of metal-on-quartz;

- 1) Place a layer of photo-active material on aluminized polypropylene in contact with said planar mask;
- 2) Expose to imaging radiation;
- 3) Process to provide a pattern of aluminum on a flexible film of polypropylene;
- 4) Place the patterned aluminum-on-polypropylene in contact with a hard, curved optically transparent blank projection mask resting on a Zerogon.

Claim 18 (withdrawn) :

A projection lithography mask made by the process of Claim 17, wherein the hard, curved optically transparent blank of step 4 is precooked with a metallized layer and a photoactive resist layer, to serve as an intermediate, and steps are added as follows:

- 5) Expose for imaging defined by the pattern;
 - 6) Process to develop the pattern as a metal-on-optic curved mask;
- and
- 7) Replicate by projection printing using said metal-on-optic curved projection mask to fabricate a metal-on-optic curved projection mask.
- :

Claim ~~19~~¹². (previously presented) :

A projection lithography scanning system for imaging a curved mask onto a curved substrate, with provisions for control of defocus, which must be minimized for scanning systems, comprising:

- a) means for continuously adjusting the position of the projection lens along its axis, during scanning, with adjustments related to changes of topography of the curved mask and substrate, such that the object distance and image distance for the conjugate points at the center of the lens field remain constant during scanning, and
- b) means to keep the size of the scanning polygon constant on the curved mask and curved substrate.

~~Claim 20. (previously presented) :~~

~~A zero power lens group~~

~~comprising~~

~~paired identical meniscus lenses arranged to carry a patterned mask for input to a projection lens so as to transmit the illumination beam without deviation and displacement to ensure high resolution pattern transfer in curved mask lithography.~~

~~Claim 21. (previously presented)~~

~~A zero power lens group according to Claim 20, arranged to serve as a curved mask / mask support subassembly for use in projection lithography, having two meniscus elements, one of which meniscus elements having a curved outer face equipped with a similarly-curved photo-opaque pattern means.~~

~~Claim 22. (previously presented) :~~

~~A zero power lens group according to Claim 21, having a concave outer surface carrying a photo-opaque pattern.~~

~~Claim 23. (previously presented) :~~

~~A zero power lens group according to Claim 21 having a convex outer surface carrying a photo-opaque pattern.~~

~~Claim 24. (previously presented)~~

~~A zero power lens group having back-to-back complementary lens elements serving as a zero-power optical device, at a position with respect to the optical axis in the optical system to transmit collimated and uncollimated beams without deviation and without shift from the line of propagation.~~